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FORM PTO-1595

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EET U.S. DEPARTMENT OF COMMERCE

(Rev. 6-93)

OMB No. 0651-0011 (exp. 4/94)

Patent and Trademark Office

Atty Dkt No. 99 P 7940 US

101193873

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Helmut Horst TEWS
Brian LEEAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Infineon Technologies North America Corporation

Internal Address: _____

Street Address: 10950 North Tantau AvenueCity: Cupertino State: CA ZIP: 95014Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____Execution Date: October 13, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: October 27, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Elsa Keller

Internal Address: _____

Siemens CorporationIntellectual Property DepartmentStreet Address: 186 Wood Avenue SouthCity: Iselin State: NJ ZIP: 088306. Total number of applications and patents involved: 17. Total Fee (37 CFR 3.41) \$ 40.00☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit Account No.

19-2179

11/04/1999 DNGUYEN 00000256 192179 09427991

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9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stanton C. Braden
Name of Person Signing
Reg. No. 32,556
SignatureOctober 27, 1999
DateTotal number of pages including cover sheet, attachments, and document: 3PATENT
REEL: 010354 FRAME: 0348

ASSIGNMENT

For good and valuable consideration, I, **Helmut Horst TEWS**, residing at 26 Millbank Road, Poughkeepsie, New York 12603, a citizen of Germany; and **Brian LEE**, residing at 425 East 76th Street #10D, New York, New York 10021, a citizen of South Korea;

Hereby sell, assign, and transfer to Infineon Technologies North America Corporation, a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at 10950 North Tantau Ave., Cupertino, CA 95014,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

INTEGRATED CIRCUIT FABRICATION

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

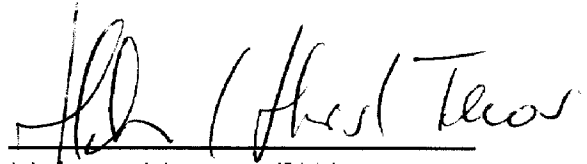
Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

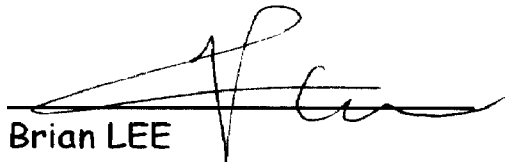
Date: 10/13/99


Helmut Horst TEWS

Witness: S. Kudzelka
(type name)

Witness: A. Gruening
(type name)

Date: 10/13/99


Brian LEE

Witness: S. Kudzelka
(type name)

Witness: A. Gruening
(type name) (A. Gruening)